



**Current Rating:** 1 Amps  
**Insulator Resistance:** 1000 Megohms min  
**Dielectric Withstanding:** AC 300V  
**Contact Resistance:** 20mΩ MAX  
**Operation Temperature:** -40~+105°C  
**Max processing temp:** 230°C for 60seconds  
**Max processing temp:** 260°C for 10seconds  
**Contact Material:** Brass  
**Insulator material:** Standard: Polyester, UL 94V-0  
**Standard:** PA6T  
**Finish:** Tin Gold Plated  
**Standard:** Gold Flash all over

Recommended P.C. Board  
 SMD Layout

**H5 X 15 - 2 XX S0 BK X 000 X**  
 1 2 3 4 5 6 7

1. Insulator material: 5. Contact Plated:
- N=PA6T T=Matte Tin over Nickel I=Gold 1μ"
  - L=LCP P=PA9T W=Matte Tin over nickel 150μ" E=Gold 5μ"
  - 2. Circuits:2-50 PIN Y=Bright Tin over Nickel G=Gold 10μ"
  - 3. Tail Style: F=Gold Flash, Matte Tin 100μ" J=Gold 10μ"
  - S0=180 A=Gold 3μ" L=Gold 15μ"
  - 4. Color: B=Gold 3μ" M=Gold 15μ"
  - BK=Black D=Gold 5μ" V=Gold 30μ"
- 6.Special Options
7. Packing:
- A=Bag B=Tube
  - D=Small box E=Cap+Reel

<p>东莞市震升电子有限公司 DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD</p>		PART NO.		H5X15-2XXS0BKX000X		.X		.XX		.XXX	
BOM		1:H5N15-250BKHC4		DRAWING NO		ZS-00019-P		EDITION:A1		ITEM: H5	
3:		2:SQ0.30-5-1-X-C12		DRAWN BY		Deng jin quan		2021-12-22		SCALE:1:1	
TEL:0769-853505015 FAX:0769-85845060		APPROVAL BY		Chen xiao guang		2021-12-23		UNIT:M.M			